

Ultra-Small, Low on Resistance Load Switch with Controlled Turn-on

Check for Samples: [TPS22913](#)

FEATURES

- Integrated Single Load Switch
- Ultra Small CSP-4 Package 0.9mm × 0.9mm, 0.5mm Pitch
- Input Voltage Range: 1.4-V to 5.5-V
- Low ON-Resistance
 - $r_{ON} = 60\text{-m}\Omega$ at $V_{IN} = 5\text{-V}$
 - $r_{ON} = 61\text{-m}\Omega$ at $V_{IN} = 3.3\text{-V}$
 - $r_{ON} = 74\text{-m}\Omega$ at $V_{IN} = 1.8\text{-V}$
 - $r_{ON} = 84\text{-m}\Omega$ at $V_{IN} = 1.5\text{-V}$
- 2-A Maximum Continuous Switch Current
- Low Threshold Control Input
- Controlled Slew-rate Options
- Under-Voltage Lock Out
- Quick Output Discharge Transistor
- Reverse Current Protection

APPLICATIONS

- Portable Industrial Equipment
- Portable Medical Equipment
- Portable Media Players
- Point Of Sales Terminal
- GPS Devices
- Digital Cameras
- Portable Instrumentation
- Smartphones

DESCRIPTION

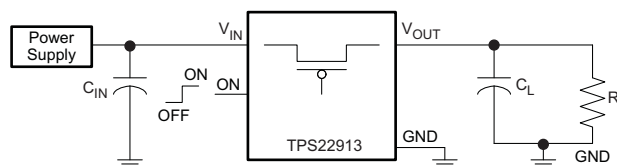
The TPS22913 is a small, low r_{ON} load switch with controlled turn on. The device contains a P-channel MOSFET that can operate over an input voltage range of 1.4 V to 5.5 V. The switch is controlled by an on/off input (ON), which is capable of interfacing directly with low-voltage control signals. The TPS22913 is active high enable.

The TPS22913 contains a 150- Ω on-chip load resistor for quick output discharge when the switch is turned off. The rise time of the device is internally controlled in order to avoid inrush current. The TPS22913 family has various slew rate options (see [Table 1](#)).

The TPS22913 device provides circuit breaker functionality by latching off the power-switch during reverse voltage situations. An internal reverse voltage comparator disables the power-switch when the output voltage is driven higher than the input (V_{IN}) to quickly (10 μ s typ) stop the flow of current towards the input side of the switch. The reverse current protection is active when the power switch is enabled (ON). Additionally, during under-voltage lockout (UVLO), or when the switch is disabled, no reverse current can flow as the switch body diode is not engaged.

The TPS22913 is available in an ultra-small, space-saving 4-pin CSP package and is characterized for operation over the free-air temperature range of -40°C to 85°C .

TYPICAL APPLICATION



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These devices have limited built-in ESD protection. The leads should be shorted together or the device placed in conductive foam during storage or handling to prevent electrostatic damage to the MOS gates.

Table 1. Feature List

DEVICE	r_{ON} (typ) at 3.3 V	SLEW RATE (typ)	QUICK OUTPUT DISCHARGE ⁽¹⁾	MAXIMUM OUTPUT CURRENT	ENABLE
TPS22913A ⁽²⁾	63 mΩ	0.1 μs/V	Yes	2-A	Active High
TPS22913B	63 mΩ	20 μs/V	Yes	2-A	Active High
TPS22913C	63 mΩ	200 μs/V	Yes	2-A	Active High
TPS22913D ⁽²⁾	63 mΩ	900 μs/V	Yes	2-A	Active High

(1) This feature discharges the output of the switch to ground through an 150-Ω resistor, preventing the output from floating.

(2) Contact local sales/distributor or factory for availability.

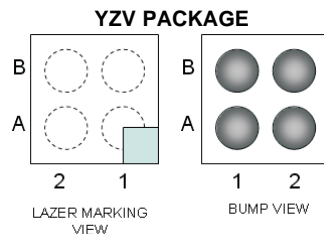
ORDERING INFORMATION

T _A	PACKAGE ⁽¹⁾		ORDERABLE PART NUMBER	TOP-SIDE MARKING/ STATUS ⁽²⁾
-40°C to 85°C	YZV (0.5mm pitch)	Tape and Reel	TPS22913AYZVR	Contact factory for availability
-40°C to 85°C	YZV (0.5mm pitch)	Tape and Reel	TPS22913BYZVR	____ 64
-40°C to 85°C	YZV (0.5mm pitch)	Tape and Reel	TPS22913CYZVR	____ 76
-40°C to 85°C	YZV (0.5mm pitch)	Tape and Reel	TPS22913DYZVR	Contact factory for availability

(1) Package drawings, standard packing quantities, thermal data, symbolization, and PCB design guidelines are available at www.ti.com/sc/package.

(2) Contact factory for details and availability for PREVIEW devices, minimum order quantities may apply.

DEVICE INFORMATION



TERMINALS ASSIGNMENTS

B	ON	GND
A	V _{IN}	V _{OUT}
	2	1

PIN FUNCTIONS

TPS22913	PIN NAME	DESCRIPTION
YZV		
B1	GND	Ground
B2	ON	Switch control input, active high. Do not leave floating
A1	V _{OUT}	Switch output
A2	V _{IN}	Switch input, bypass this input with a ceramic capacitor to ground

BLOCK DIAGRAM

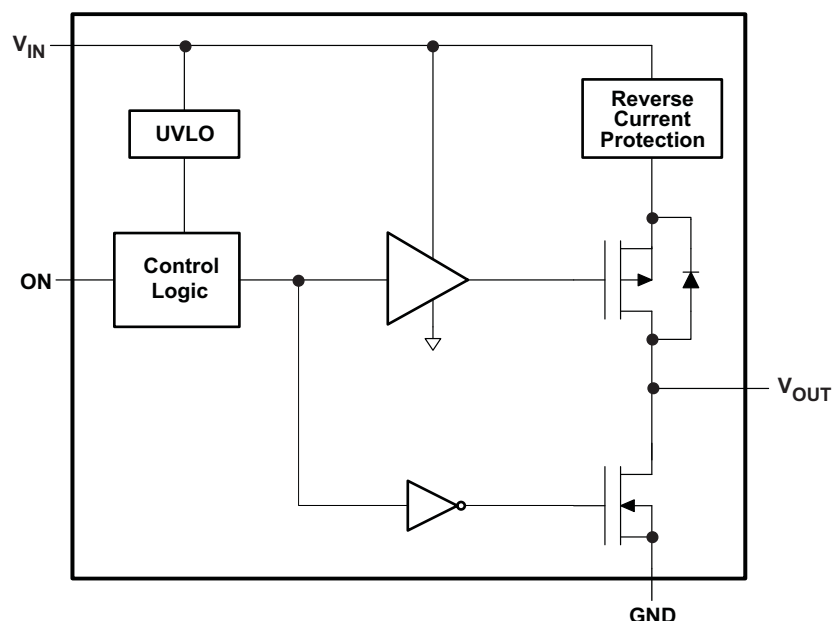


Table 2. FUNCTION TABLE

ON	V_{IN} to V_{OUT}	V_{OUT} to GND ⁽¹⁾
L	OFF	ON
H	ON	OFF

(1) See Application section 'Output Pull-Down'

ABSOLUTE MAXIMUM RATINGS

		VALUE	UNIT
V_{IN}	Input voltage range	-0.3 to 6	V
V_{OUT}	Output voltage range	$V_{IN} + 0.3$	V
V_{ON}	Input voltage range	-0.3 to 6	V
I_{MAX}	Maximum continuous switch current	2	A
I_{PLS}	Maximum pulsed switch current, pulse <300 μ S, 2% duty cycle	2.5	A
T_A	Operating free-air temperature range	-40 to 85	$^{\circ}$ C
T_J	Maximum junction temperature	125	$^{\circ}$ C
T_{STG}	Storage temperature range	-65 to 150	$^{\circ}$ C
T_{LEAD}	Maximum lead temperature (10-s soldering time)	300	$^{\circ}$ C
ESD	Electrostatic discharge protection	Human-Body Model (HBM) (V_{IN} , V_{OUT} , GND pins)	2000
		Charged-Device Model (CDM) (V_{IN} , V_{OUT} , ON, GND pins)	1000

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THERMAL INFORMATION

THERMAL METRIC ⁽¹⁾		TPS22913		UNITS
		CSP		
		(4) PINS		
θ_{JA}	Junction-to-ambient thermal resistance	189.1		°C/W
θ_{JCTop}	Junction-to-case (top) thermal resistance	1.9		
θ_{JB}	Junction-to-board thermal resistance	36.8		
ψ_{JT}	Junction-to-top characterization parameter	11.3		
ψ_{JB}	Junction-to-board characterization parameter	36.8		
θ_{JCbot}	Junction-to-case (bottom) thermal resistance	N/A		

(1) For more information about traditional and new thermal metrics, see the *IC Package Thermal Metrics* application report, [SPRA953](#).

RECOMMENDED OPERATING CONDITIONS

			MIN	MAX	UNIT
V_{IN}	Input voltage range		1.4	5.5	V
V_{ON}	ON voltage range		0	5.5	V
V_{OUT}	Output voltage range			V_{IN}	
V_{IH}	High-level input voltage, ON	$V_{IN} = 3.61 \text{ V to } 5.5 \text{ V}$	1.1	5.5	V
		$V_{IN} = 1.4 \text{ V to } 3.6 \text{ V}$	1.1	5.5	V
V_{IL}	Low-level input voltage, ON	$V_{IN} = 3.61 \text{ V to } 5.5 \text{ V}$		0.6	V
		$V_{IN} = 1.4 \text{ V to } 3.6 \text{ V}$		0.4	V
C_{IN}	Input Capacitor		1 ⁽¹⁾		μF

(1) Refer to the application section.

ELECTRICAL CHARACTERISTICS

VIN = 1.4 V to 5.5 V, TA = –40°C to 85°C (unless otherwise noted)

PARAMETER	TEST CONDITIONS	TA	MIN	TYP	MAX	UNIT
I _{IN} Quiescent current	I _{OUT} = 0, V _{IN} = V _{ON} = 5.25 V	Full		2	10	μA
	I _{OUT} = 0, V _{IN} = V _{ON} = 4.2 V			2	7.0	
	I _{OUT} = 0, V _{IN} = V _{ON} = 3.6 V			2	7.0	
	I _{OUT} = 0, V _{IN} = V _{ON} = 2.5 V			0.9	5	
	I _{OUT} = 0, V _{IN} = V _{ON} = 1.5 V			0.7	5	
I _{IN(off)} Off supply current	V _{ON} = GND, V _{OUT} = Open, V _{IN} = 5.25 V	Full		1.2	10	μA
	V _{ON} = GND, V _{OUT} = Open, V _{IN} = 4.2 V			0.2	7.0	
	V _{ON} = GND, V _{OUT} = Open, V _{IN} = 3.6 V			0.1	7.0	
	V _{ON} = GND, V _{OUT} = Open, V _{IN} = 2.5 V			0.1	5	
	V _{ON} = GND, V _{OUT} = Open, V _{IN} = 1.5 V			0.1	5	
I _{IN(Leakage)} Leakage current	V _{ON} = GND, V _{OUT} = 0, V _{IN} = 5.25 V	Full		1.2	10	μA
	V _{ON} = GND, V _{OUT} = 0, V _{IN} = 4.2 V			0.2	7.0	
	V _{ON} = GND, V _{OUT} = 0, V _{IN} = 3.6 V			0.1	7.0	
	V _{ON} = GND, V _{OUT} = 0, V _{IN} = 2.5 V			0.1	5	
	V _{ON} = GND, V _{OUT} = 0, V _{IN} = 1.5 V			0.1	5	
r _{ON} On-resistance	V _{IN} = 5.25 V, I _{OUT} = –200 mA	25°C		60	80	mΩ
		Full			110	
	V _{IN} = 5.0 V, I _{OUT} = –200 mA	25°C		60	80	
		Full			110	
	V _{IN} = 4.2 V, I _{OUT} = –200 mA	25°C		60	80	
		Full			110	
	V _{IN} = 3.3 V, I _{OUT} = –200 mA	25°C		60.7	80	
		Full			110	
	V _{IN} = 2.5 V, I _{OUT} = –200 mA	25°C		63.4	90	
		Full			120	
	V _{IN} = 1.8 V, I _{OUT} = –200 mA	25°C		74.2	100	
		Full			130	
	V _{IN} = 1.5 V, I _{OUT} = –200 mA	25°C		83.9	120	
		Full			150	
RPD Output pull down resistance	V _{IN} = 3.3 V, V _{ON} = 0, I _{OUT} = 30 mA	25°C		153	200	Ω
UVLO Under voltage lockout	V _{IN} increasing, V _{ON} = 3.6 V, I _{OUT} = –100 mA	Full			1.2	V
			V _{IN} decreasing, V _{ON} 3.6 V, R _L = 10 Ω		0.50	
I _{ON} ON input leakage current	V _{ON} = 1.4 V to 5.25 V or GND	Full			1	μA
V _{RVP} Reverse Current Voltage Threshold				44		mV
t _{DELAY} Reverse Current Response Delay	V _{IN} = 5V			10		μs

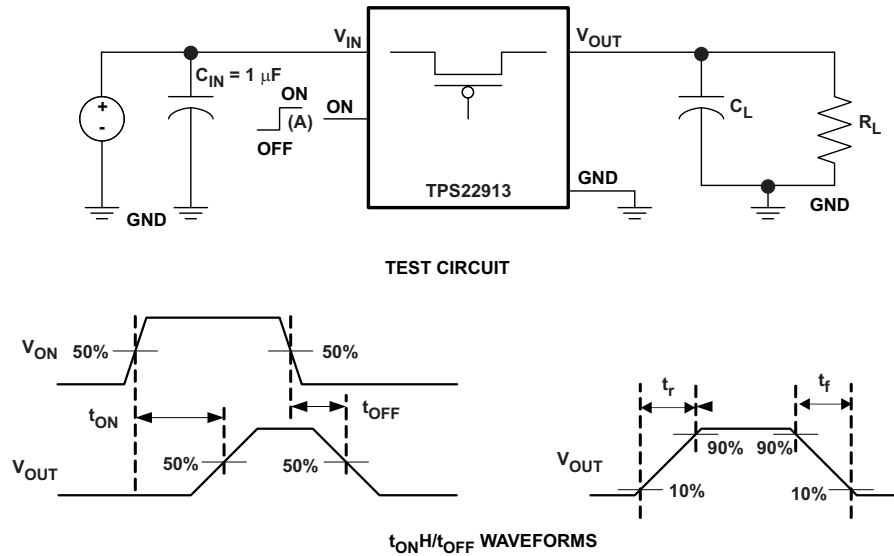
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SWITCHING CHARACTERISTICS

PARAMETER	TEST CONDITION	TPS22913 B	TPS22913 C	UNIT	
		TYP	TYP		
V_{IN} = 5 V, T_A = 25°C (unless otherwise noted)					
t _{ON}	Turn-ON time	R _L = 10 Ω, C _L = 0.1 μF	76	770	μs
t _{OFF}	Turn-OFF time	R _L = 10 Ω, C _L = 0.1 μF	6.6	6.6	
t _R	V _{OUT} rise time	R _L = 10 Ω, C _L = 0.1 μF	82	838	
t _F	V _{OUT} fall time	R _L = 10 Ω, C _L = 0.1 μF	3	3	
V_{IN} = 3.3 V, T_A = 25°C (unless otherwise noted)					
t _{ON}	Turn-ON time	R _L = 10 Ω, C _L = 0.1 μF	102	1048	μs
t _{OFF}	Turn-OFF time	R _L = 10 Ω, C _L = 0.1 μF	8.5	8.6	
t _R	V _{OUT} rise time	R _L = 10 Ω, C _L = 0.1 μF	97	980	
t _F	V _{OUT} fall time	R _L = 10 Ω, C _L = 0.1 μF	3	3	
V_{IN} = 1.5 V, T_A = 25°C (unless otherwise noted)					
t _{ON}	Turn-ON time	R _L = 10 Ω, C _L = 0.1 μF	234	2344	μs
t _{OFF}	Turn-OFF time	R _L = 10 Ω, C _L = 0.1 μF	17	18	
t _R	V _{OUT} rise time	R _L = 10 Ω, C _L = 0.1 μF	244	1823	
t _F	V _{OUT} fall time	R _L = 10 Ω, C _L = 0.1 μF	6.5	6.5	

PARAMETRIC MEASUREMENT INFORMATION



(A) Rise and fall times of the control signal is 100 ns.

A. Rise and fall times of the control signal is 100 ns.

Figure 1. Test Circuit and t_{ON}/t_{OFF} Waveforms

TYPICAL CHARACTERISTICS

ON-STATE RESISTANCE
vs
INPUT VOLTAGE

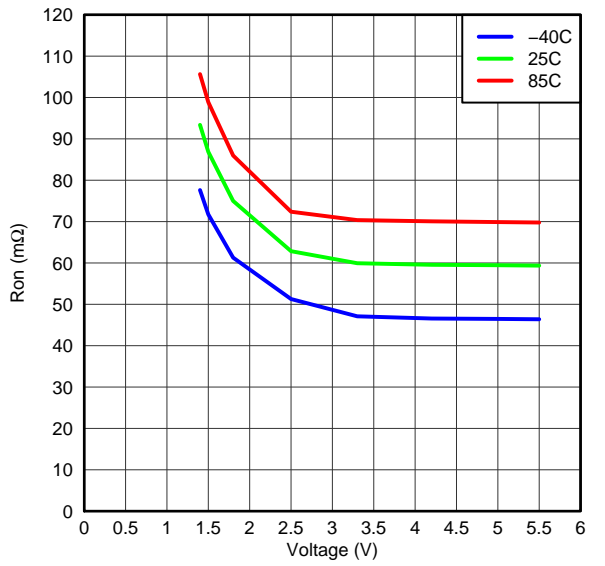


Figure 2.

ON INPUT THRESHOLD

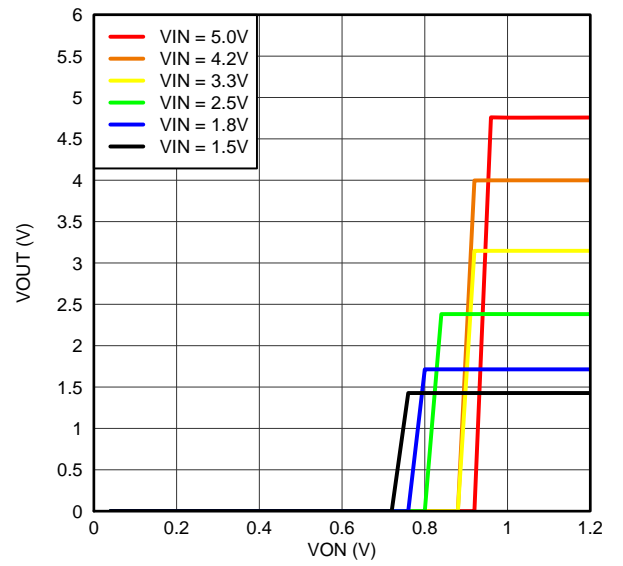


Figure 3.

INPUT CURRENT, QUIESCENT
vs
INPUT VOLTAGE

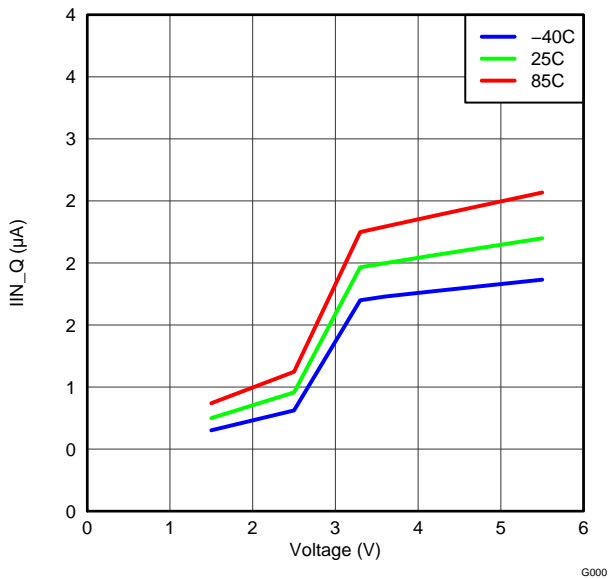


Figure 4.

INPUT CURRENT, LEAK
vs
INPUT VOLTAGE

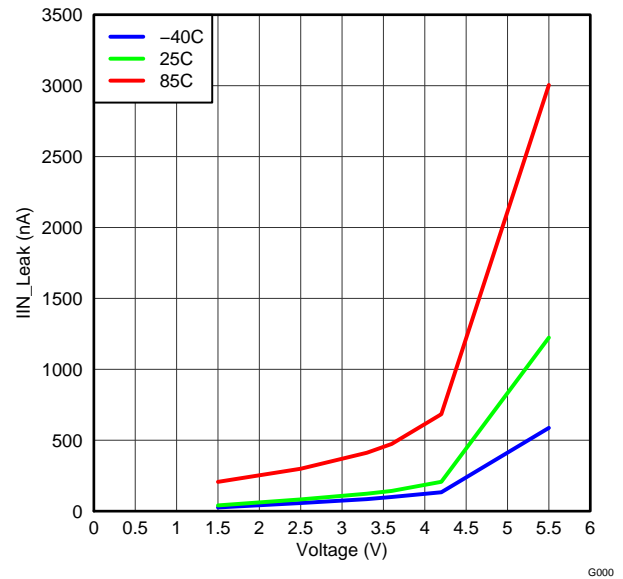


Figure 5.

TYPICAL CHARACTERISTICS (continued)

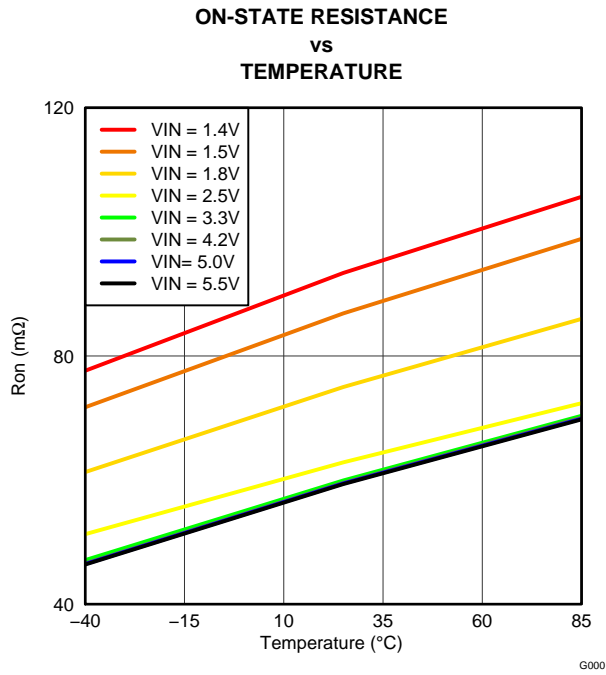


Figure 6.

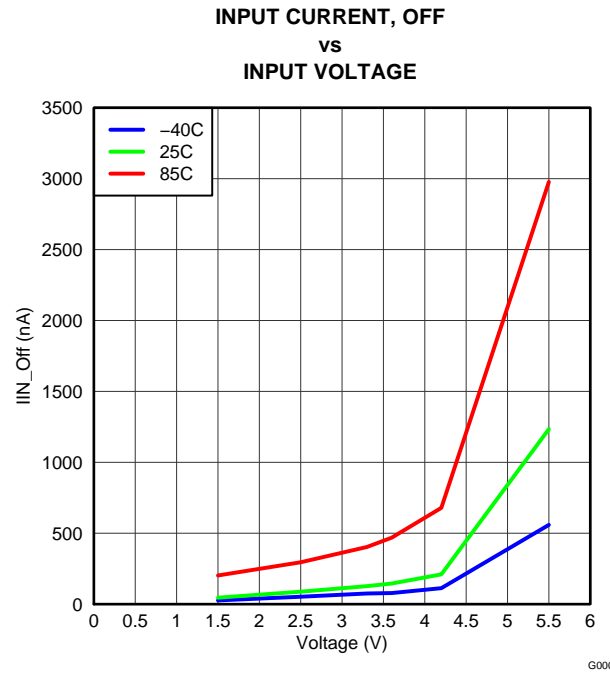


Figure 7.

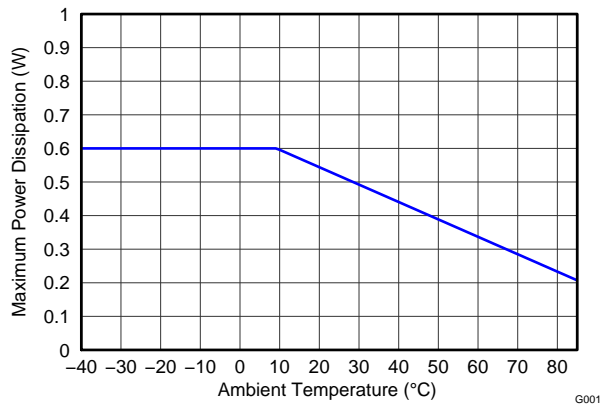


Figure 8. Allowable Power Dissipation

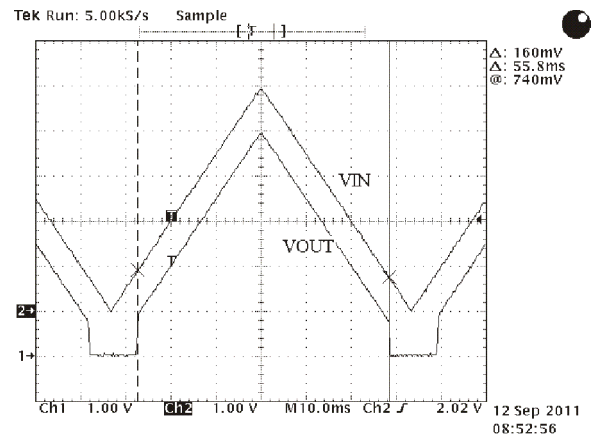


Figure 9. ULVO Response I_{OUT} = -100mA

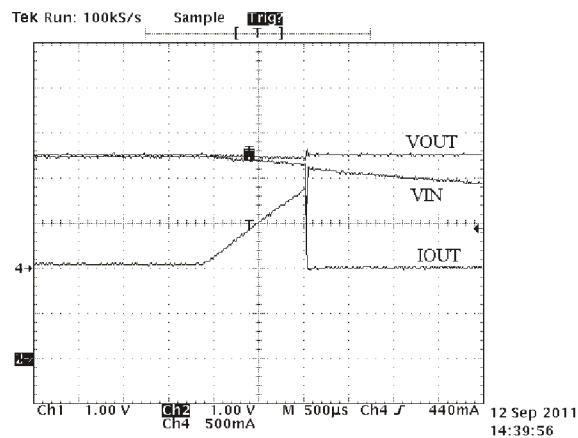


Figure 10. Reverse Current Protection V_{OUT} = 3.3V, V_{IN} = 3.3V Decreasing to 0V

TYPICAL CHARACTERISTICS (continued)
TYPICAL AC CHARACTERISTICS FOR TPS22913B

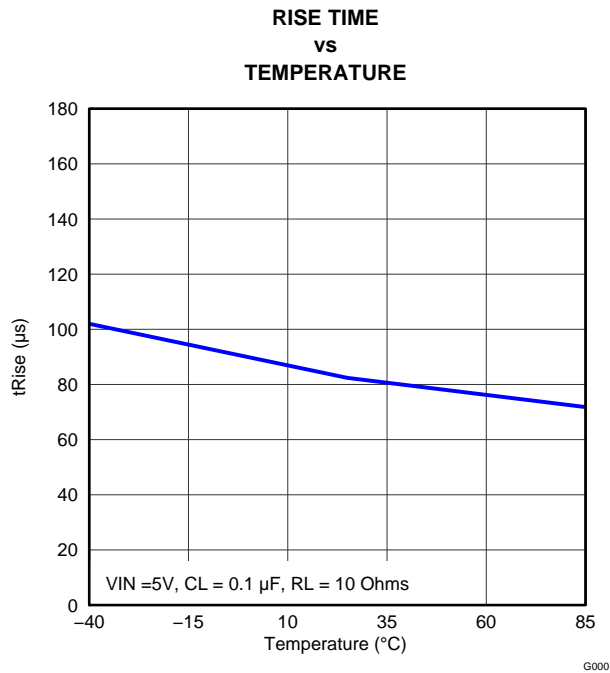


Figure 11.

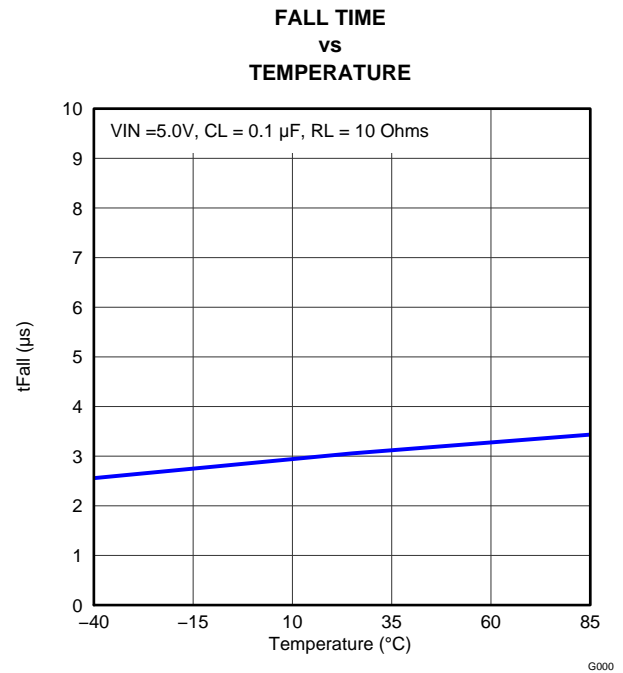


Figure 12.

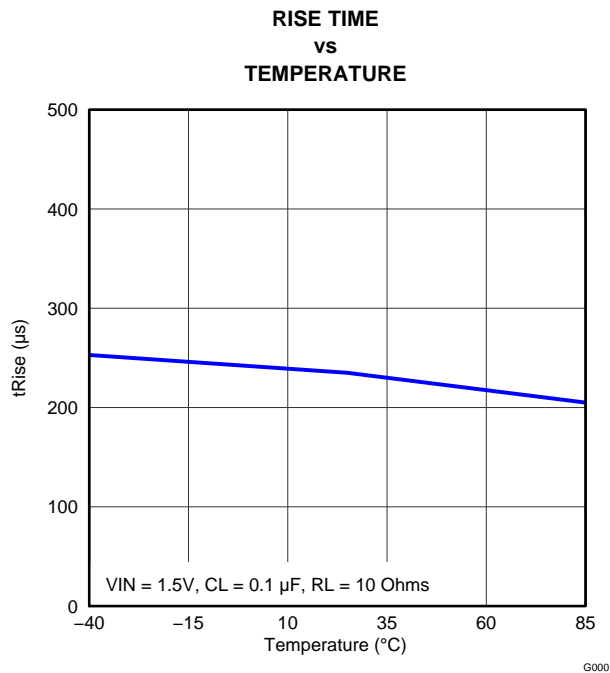


Figure 13.

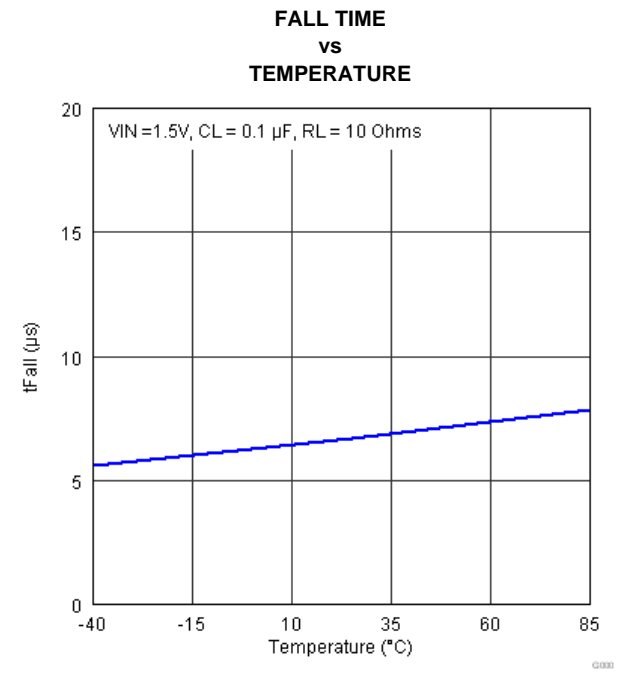


Figure 14.

TYPICAL CHARACTERISTICS (continued)

TURN-ON TIME
vs
TEMPERATURE

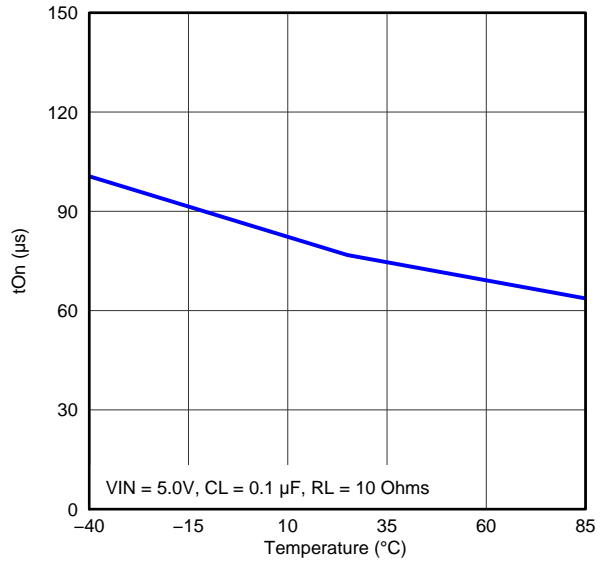


Figure 15.

TURN-OFF TIME
vs
TEMPERATURE

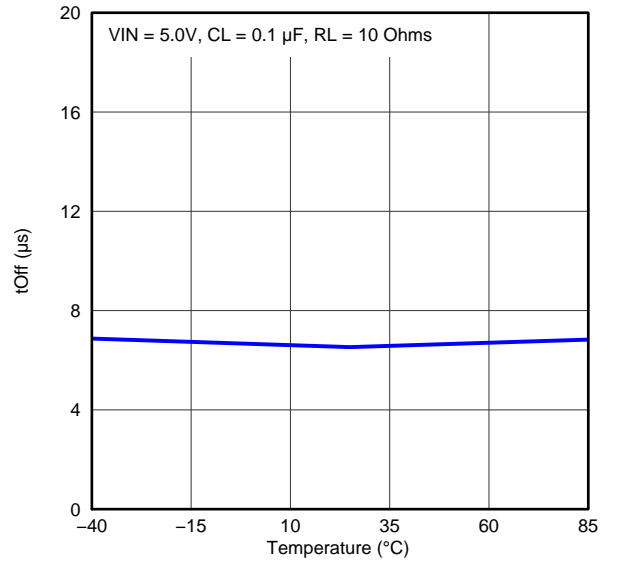


Figure 16.

TURN-ON TIME
vs
TEMPERATURE

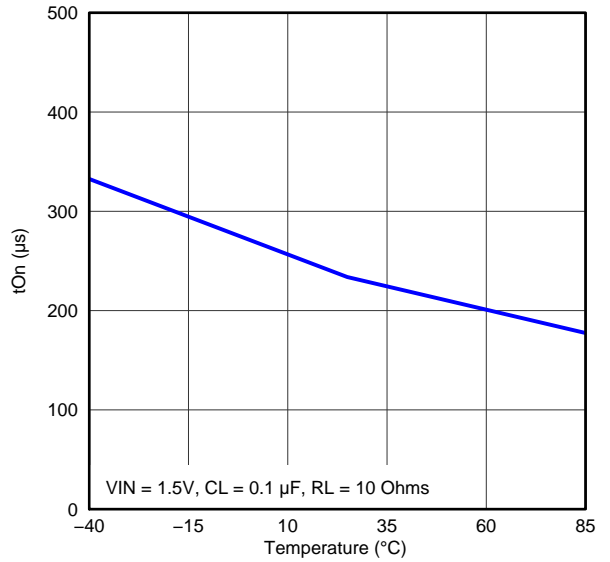


Figure 17.

TURN-OFF TIME
vs
TEMPERATURE

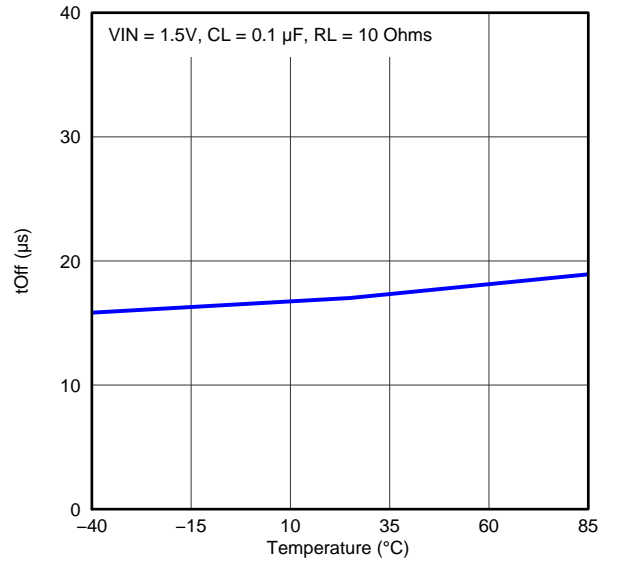


Figure 18.

TYPICAL CHARACTERISTICS (continued)

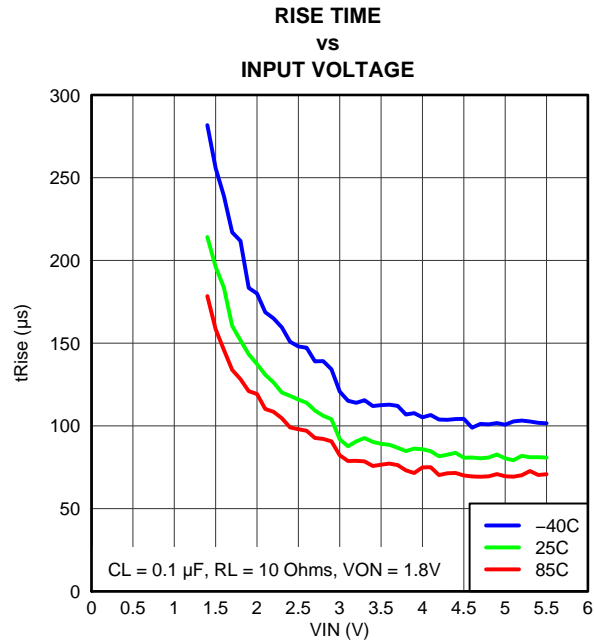


Figure 19.

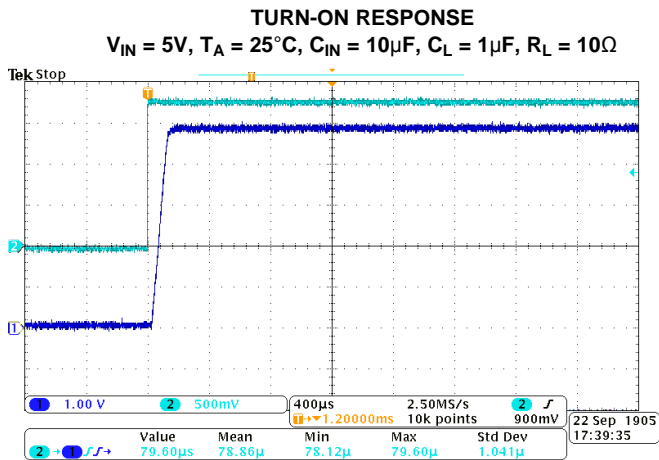


Figure 20.

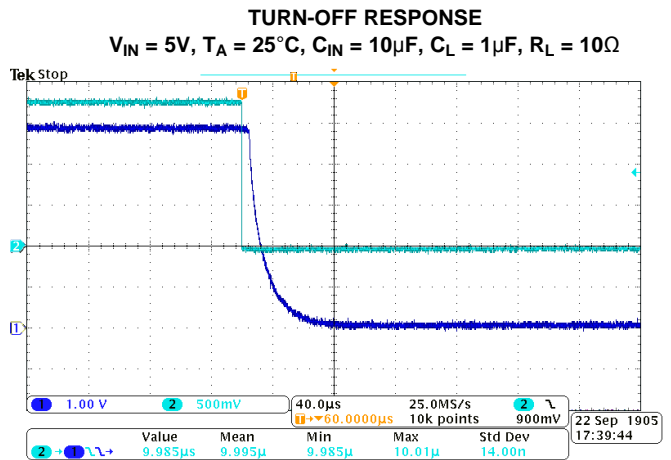


Figure 21.

TYPICAL CHARACTERISTICS (continued)

TURN-ON RESPONSE TIME

$V_{IN} = 5V, T_A = 25^\circ C, C_{IN} = 1\mu F, C_L = 0.1\mu F, R_L = 10\Omega$

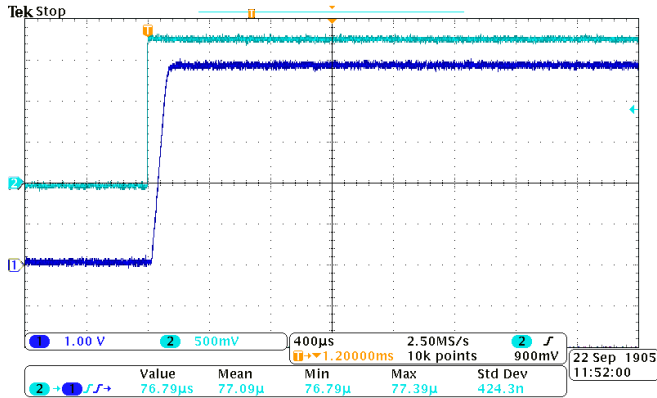


Figure 22.

TURN-OFF RESPONSE TIME

$V_{IN} = 5V, T_A = 25^\circ C, C_{IN} = 1\mu F, C_L = 0.1\mu F, R_L = 10\Omega$

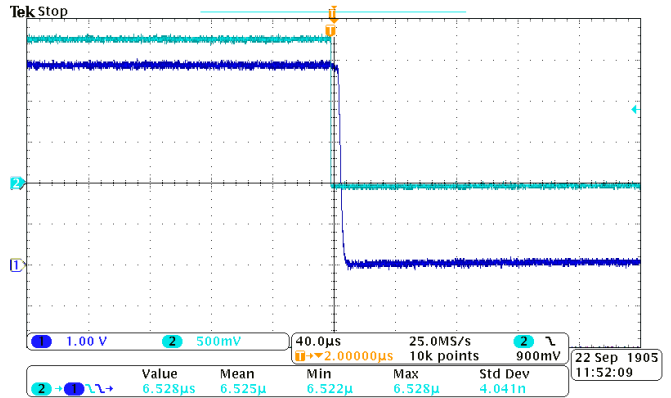


Figure 23.

TURN-Of RESPONSE TIME

$V_{IN} = 1.5V, T_A = 25^\circ C, C_{IN} = 10\mu F, C_L = 1\mu F, R_L = 10\Omega$

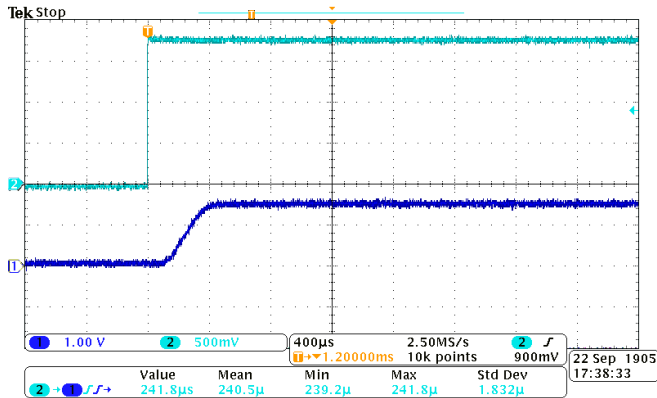


Figure 24.

TURN-Of RESPONSE TIME

$V_{IN} = 1.5V, T_A = 25^\circ C, C_{IN} = 10\mu F, C_L = 1\mu F, R_L = 10\Omega$

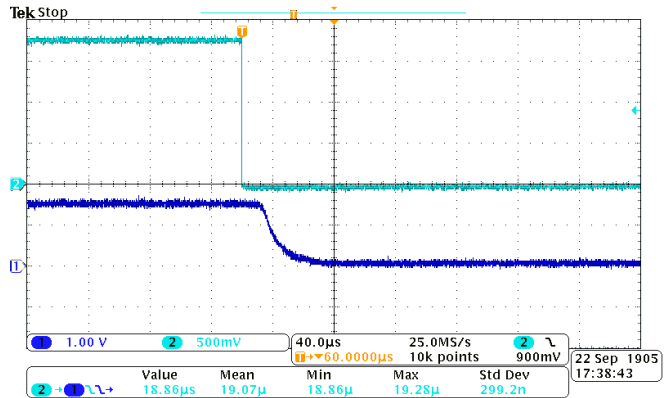


Figure 25.

TURN-Of RESPONSE TIME

$V_{IN} = 1.5V, T_A = 25^\circ C, C_{IN} = 1\mu F, C_L = 0.1\mu F, R_L = 10\Omega$

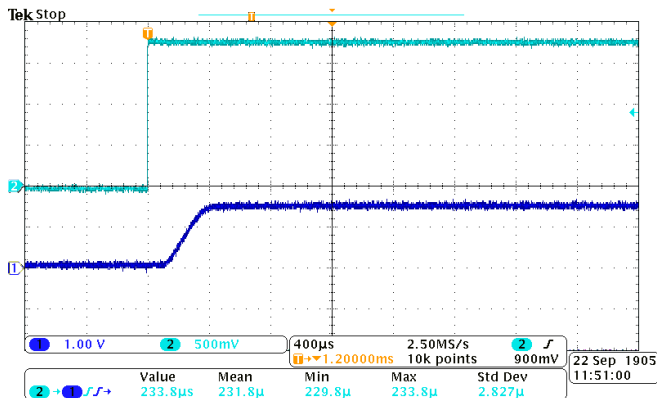


Figure 26.

TURN-Of RESPONSE TIME

$V_{IN} = 1.5V, T_A = 25^\circ C, C_{IN} = 1\mu F, C_L = 0.1\mu F, R_L = 10\Omega$

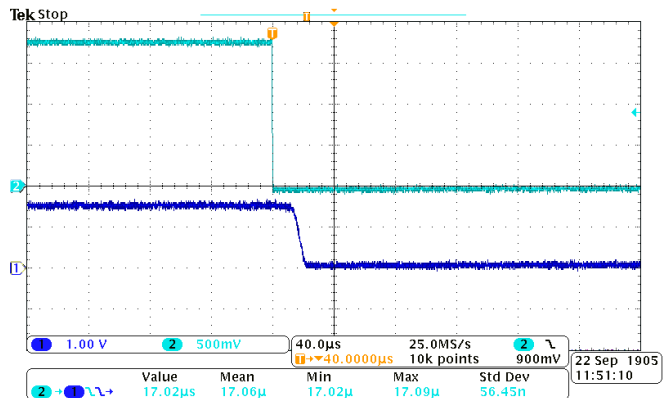


Figure 27.

TYPICAL CHARACTERISTICS (continued)
TYPICAL AC CHARACTERISTICS FOR TPS22913C

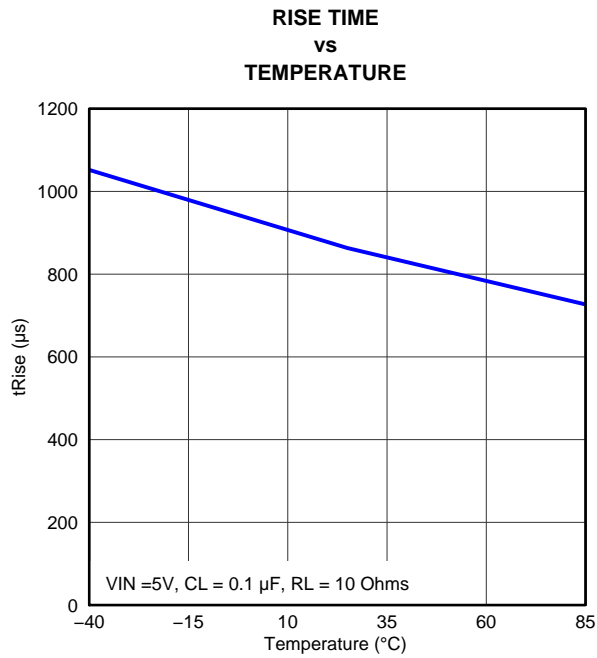


Figure 28.

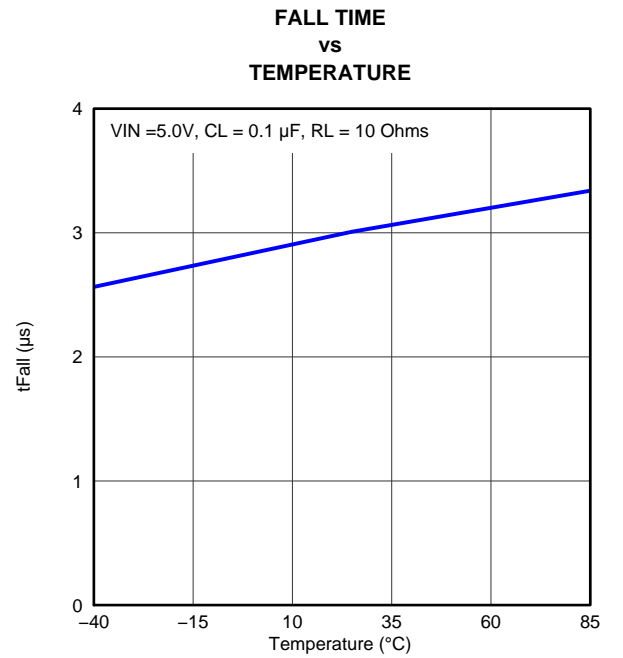


Figure 29.

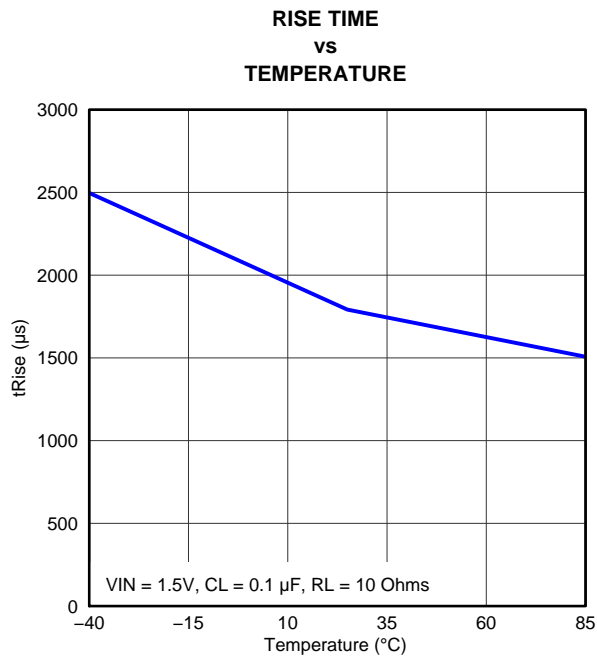


Figure 30.

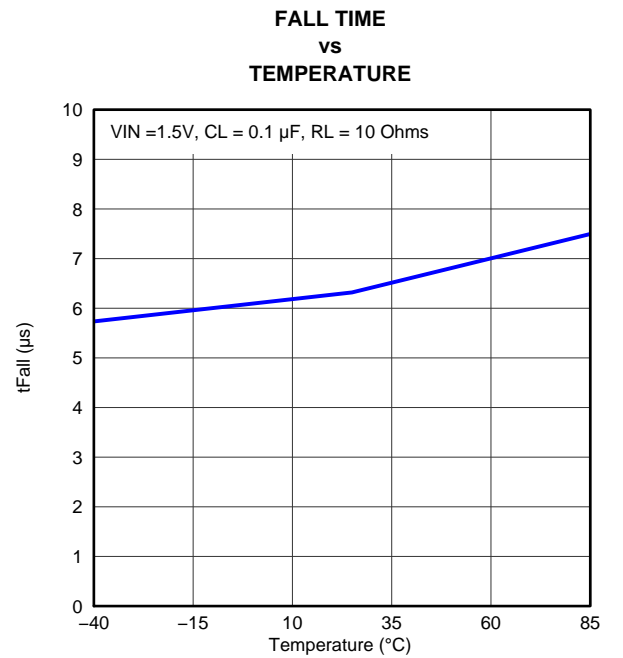


Figure 31.

TYPICAL CHARACTERISTICS (continued)

TURN-ON TIME
vs
TEMPERATURE

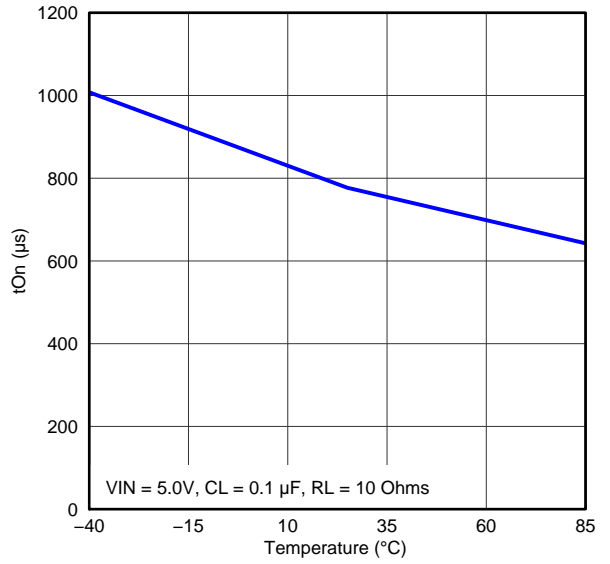


Figure 32.

TURN-OFF TIME
vs
TEMPERATURE

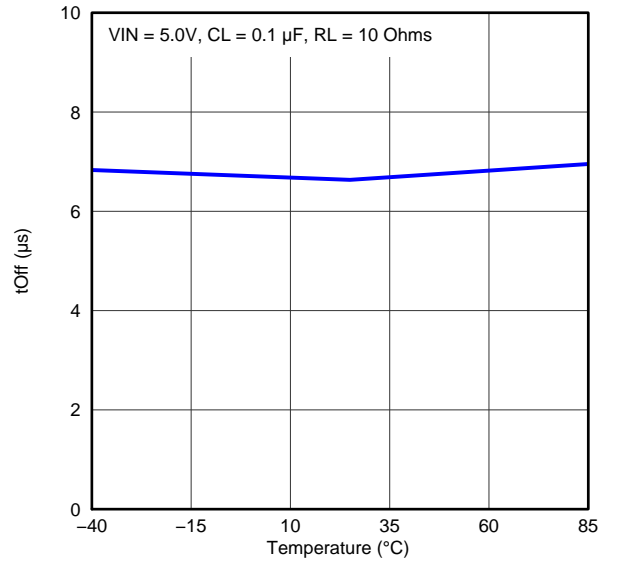


Figure 33.

TURN-ON TIME
vs
TEMPERATURE

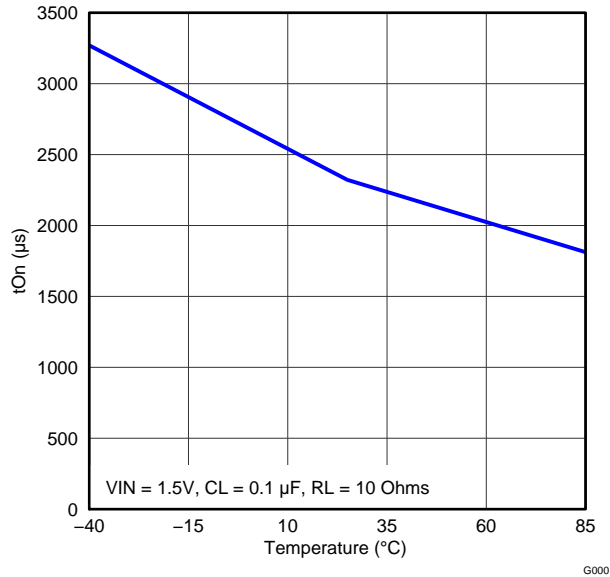


Figure 34.

TURN-OFF TIME
vs
TEMPERATURE

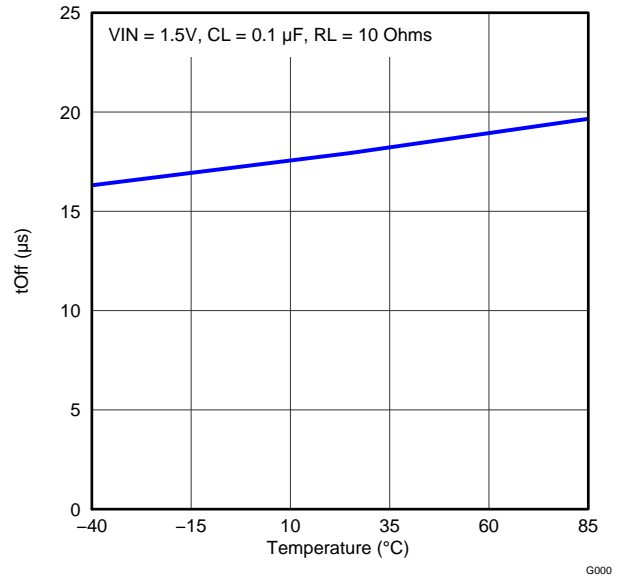


Figure 35.

TYPICAL CHARACTERISTICS (continued)

RISE TIME
vs
INPUT VOLTAGE

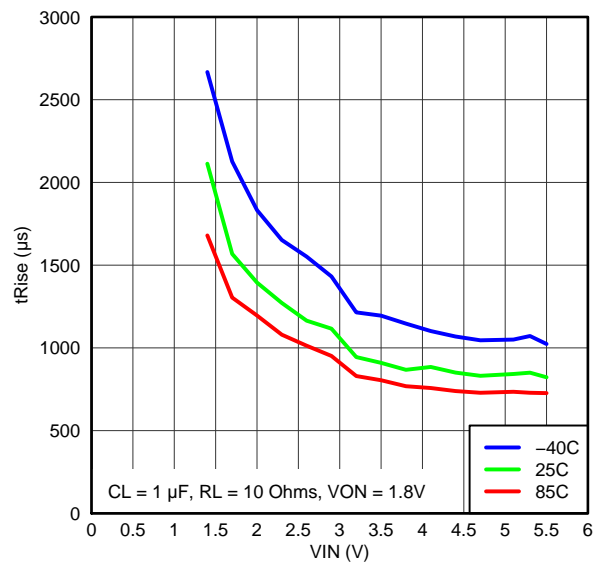


Figure 36.

TURN-ON RESPONSE

V_{IN} = 5V, T_A = 25°C, C_{IN} = 10µF, C_L = 1µF, R_L = 10Ω

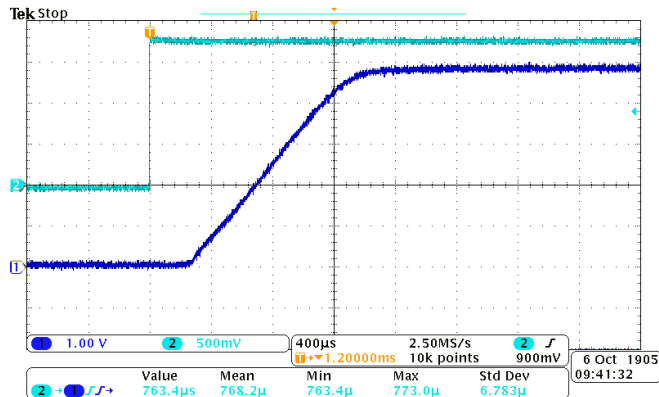


Figure 37.

TURN-OFF RESPONSE

V_{IN} = 5V, T_A = 25°C, C_{IN} = 10µF, C_L = 1µF, R_L = 10Ω

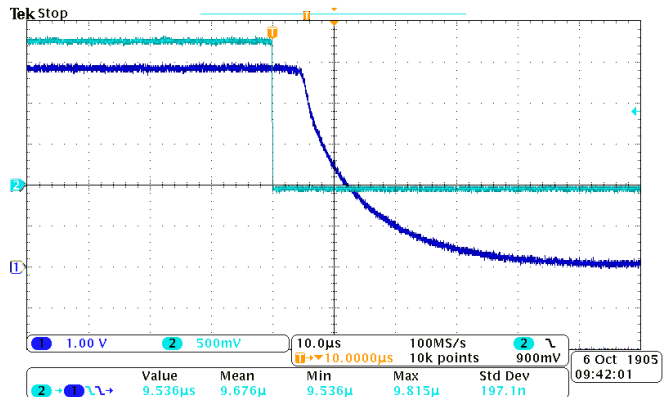


Figure 38.

TYPICAL CHARACTERISTICS (continued)

TURN-ON RESPONSE TIME

$V_{IN} = 5V, T_A = 25^\circ C, C_{IN} = 1\mu F, C_L = 0.1\mu F, R_L = 10\Omega$

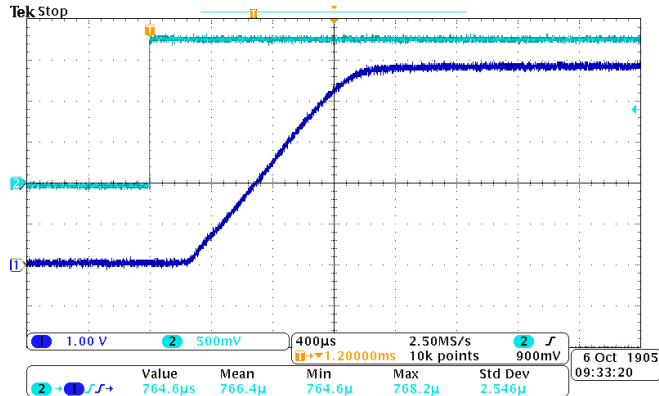


Figure 39.

TURN-OFF RESPONSE TIME

$V_{IN} = 5V, T_A = 25^\circ C, C_{IN} = 1\mu F, C_L = 0.1\mu F, R_L = 10\Omega$

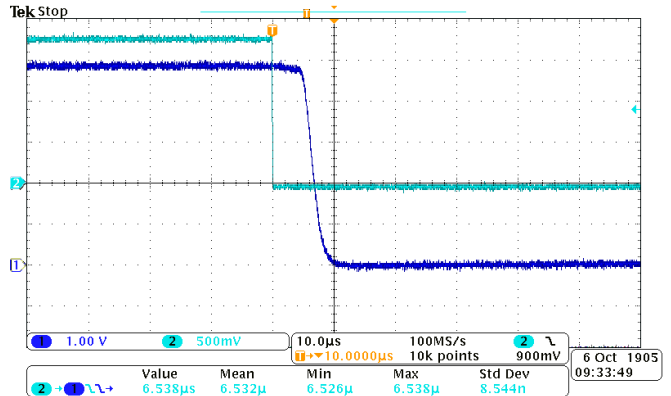


Figure 40.

TURN-Of RESPONSE TIME

$V_{IN} = 1.5V, T_A = 25^\circ C, C_{IN} = 10\mu F, C_L = 1\mu F, R_L = 10\Omega$

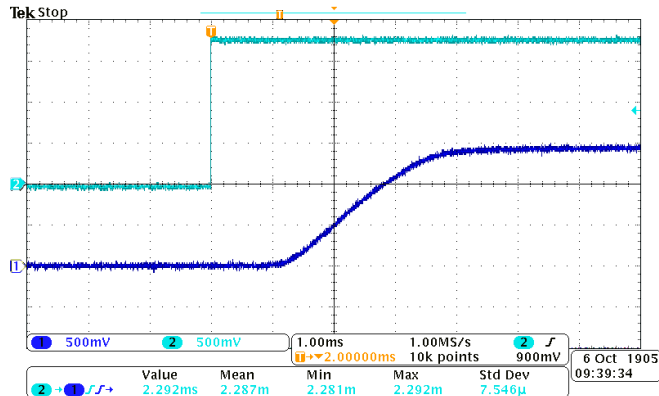


Figure 41.

TURN-Of RESPONSE TIME

$V_{IN} = 1.5V, T_A = 25^\circ C, C_{IN} = 10\mu F, C_L = 1\mu F, R_L = 10\Omega$

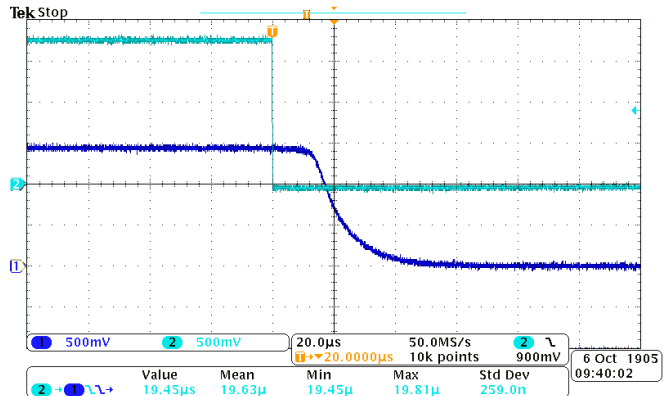


Figure 42.

TURN-Of RESPONSE TIME

$V_{IN} = 1.5V, T_A = 25^\circ C, C_{IN} = 1\mu F, C_L = 0.1\mu F, R_L = 10\Omega$

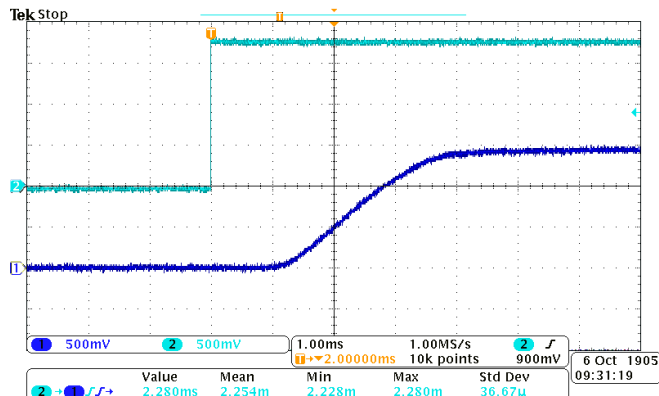


Figure 43.

TURN-Of RESPONSE TIME

$V_{IN} = 1.5V, T_A = 25^\circ C, C_{IN} = 1\mu F, C_L = 0.1\mu F, R_L = 10\Omega$

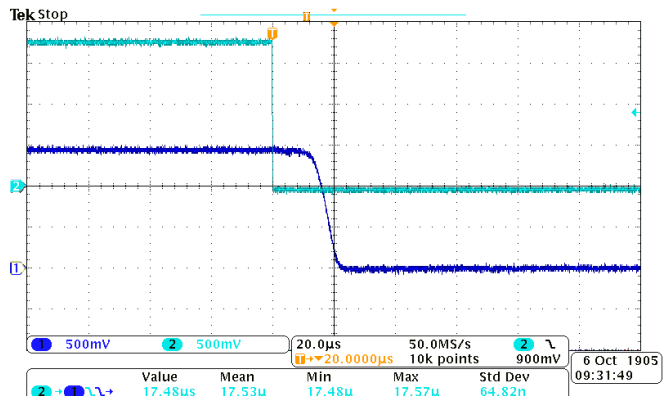


Figure 44.

APPLICATION INFORMATION

On/Off Control

The ON pin controls the state of the switch. Asserting ON high enables the switch. ON is active high and has a low threshold, making it capable of interfacing with low-voltage signals. The ON pin is compatible with standard GPIO logic threshold. It can be used with any microcontroller with 1.8-V, 2.5-V or 3.3-V GPIOs.

Input Capacitor

To limit the voltage drop on the input supply caused by transient inrush currents when the switch turns on into a discharged load capacitor or short-circuit, a capacitor needs to be placed between VIN and GND. A 1- μ F ceramic capacitor, CIN, placed close to the pins is usually sufficient. Higher values of CIN can be used to further reduce the voltage drop.

Output Capacitor

A C_{IN} to C_L ratio of 10 to 1 is recommended for minimizing V_{IN} dip caused by inrush currents during startup.

Output Pull-Down

The output pulldown is active when the user is turning off the main pass FET. The pulldown discharges the output rail to approximately 10% of the rail, and then the output pulldown is automatically disconnected to optimize the shutdown current.

Under-Voltage Lockout

The under-voltage lockout turns-off the switch if the input voltage drops below the under-voltage lockout threshold. With the ON pin active the input voltage rising above the under-voltage lockout threshold will cause a controlled turn-on of the switch which limits current over-shoots. During under-voltage lockout (UVLO), no reverse current can flow as the body diode is not engaged.

Reverse Current Protection

In a scenario where V_{OUT} is greater than V_{IN} , there could be reverse current through the body diode of the PMOS FET. The TPS22913 monitors the current through the FET and shuts off the FET when a reverse current is detected. The FET, and the output, resumes normal operation when the reverse current scenario is no longer present. When the reverse current protection (RCP) is active, no reverse current can flow as the body diode is not engaged. During under-voltage lockout (UVLO), or when the switch is disabled, no reverse current can flow as the body diode is not engaged.

Use the following formula to calculate the amount of reverse current for a particular application:

$$I_{RC} = \frac{0.044V}{R_{ON(VIN)}}$$

Where,

I_{RC} is the amount of reverse current,

$R_{ON(VIN)}$ is the on-resistance at the VIN of the reverse current condition.

Board Layout

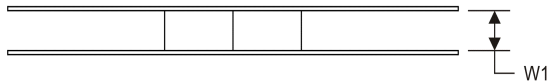
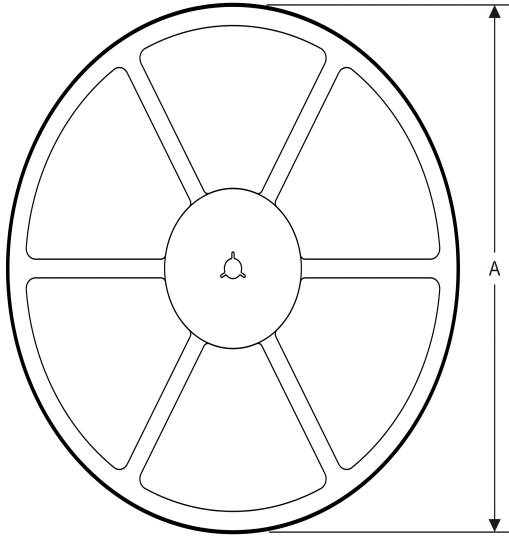
For best performance, all traces should be as short as possible. To be most effective, the input and output capacitors should be placed close to the device to minimize the effects that parasitic trace inductances may have on normal operation. Using wide traces for V_{IN} , V_{OUT} , and GND helps minimize the parasitic electrical effects along with minimizing the case to ambient thermal impedance.

PACKAGING INFORMATION

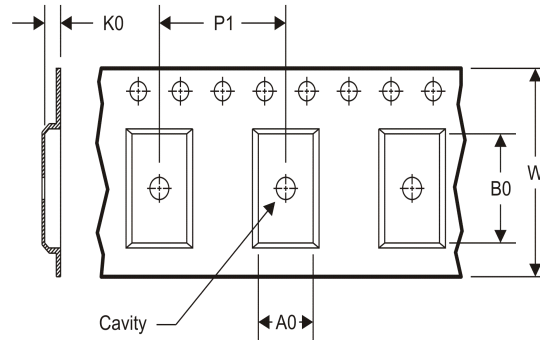
Orderable Device	Status ⁽¹⁾	Package Type	Package Drawing	Pins	Package Qty	Eco Plan ⁽²⁾	Lead/ Ball Finish	MSL Peak Temp ⁽³⁾	Samples (Requires Login)
TPS22913BYZVR	ACTIVE	DSBGA	YZV	4	3000	Green (RoHS & no Sb/Br)	SNAGCU	Level-1-260C-UNLIM	
TPS22913BYZVT	ACTIVE	DSBGA	YZV	4	250	Green (RoHS & no Sb/Br)	SNAGCU	Level-1-260C-UNLIM	
TPS22913CZVVR	ACTIVE	DSBGA	YZV	4	3000	Green (RoHS & no Sb/Br)	SNAGCU	Level-1-260C-UNLIM	
TPS22913CZVVT	PREVIEW	DSBGA	YZV	4	250	Green (RoHS & no Sb/Br)	SNAGCU	Level-1-260C-UNLIM	

TAPE AND REEL INFORMATION

REEL DIMENSIONS



TAPE DIMENSIONS



A0	Dimension designed to accommodate the component width
B0	Dimension designed to accommodate the component length
K0	Dimension designed to accommodate the component thickness
W	Overall width of the carrier tape
P1	Pitch between successive cavity centers

TAPE AND REEL INFORMATION

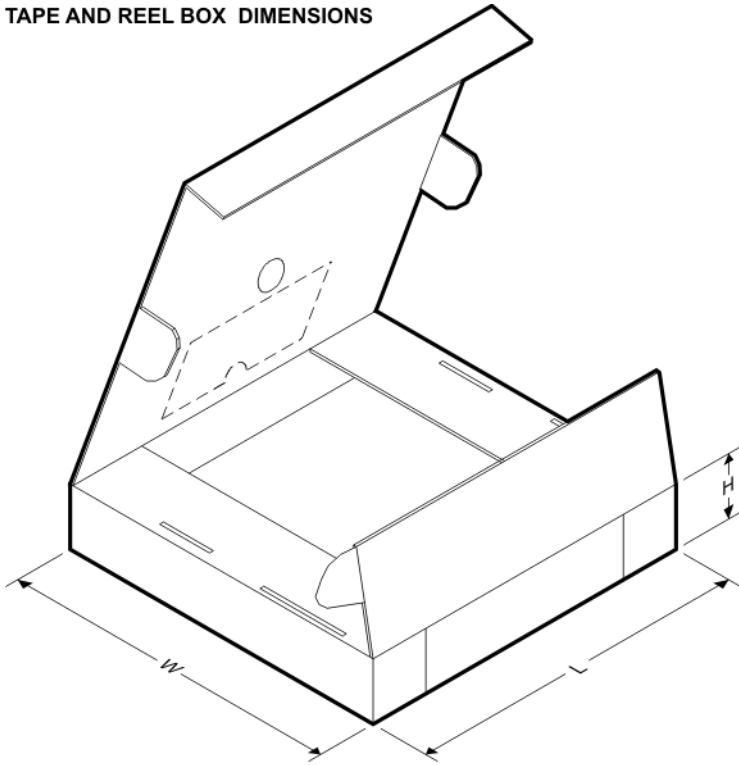
*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Reel Diameter (mm)	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadrant
TPS22913BYZVR	DSBGA	YZV	4	3000	178.0	9.2	1.0	1.0	0.63	4.0	8.0	Q1
TPS22913BYZVT	DSBGA	YZV	4	250	178.0	9.2	1.0	1.0	0.63	4.0	8.0	Q1
TPS22913CYZVR	DSBGA	YZV	4	3000	178.0	9.2	1.0	1.0	0.63	4.0	8.0	Q1
TPS22913CYZVT	DSBGA	YZV	4	250	178.0	9.2	1.0	1.0	0.63	4.0	8.0	Q1

PACKAGE MATERIALS INFORMATION

28-Sep-2011

TAPE AND REEL BOX DIMENSIONS

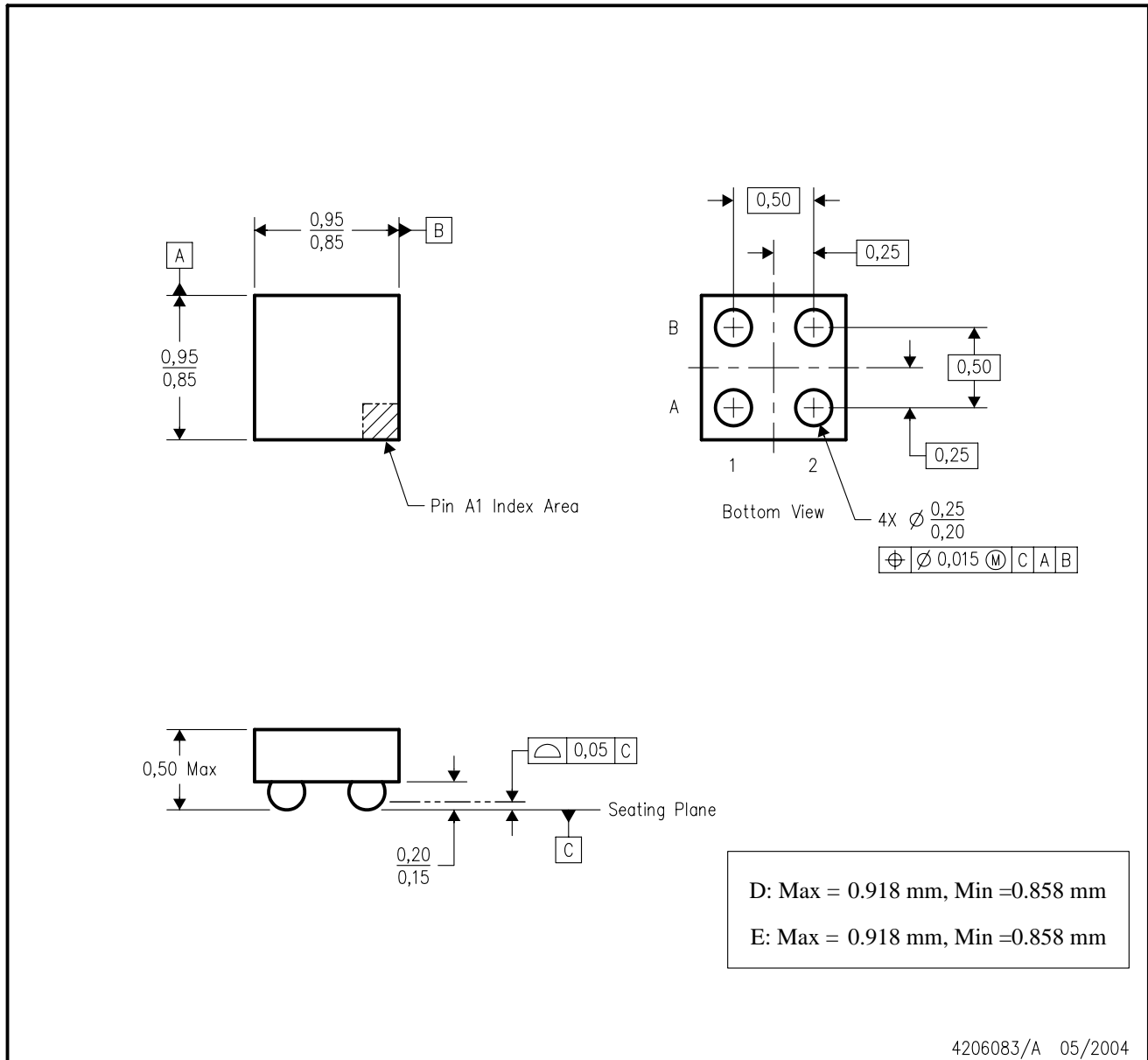


*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Length (mm)	Width (mm)	Height (mm)
TPS22913BYZVR	DSBGA	YZV	4	3000	220.0	220.0	35.0
TPS22913BYZVT	DSBGA	YZV	4	250	220.0	220.0	35.0
TPS22913CYZVR	DSBGA	YZV	4	3000	220.0	220.0	35.0
TPS22913CYZVT	DSBGA	YZV	4	250	220.0	220.0	35.0

YZV (S-XBGA-N4)

DIE-SIZE BALL GRID ARRAY



- NOTES:
- A. All linear dimensions are in millimeters.
 - B. This drawing is subject to change without notice.
 - C. NanoFree™ package configuration.
 - D. This package contains lead-free balls. Refer to the 4 YEV package (drawing 4206082) for tin-lead (SnPb) balls.